OSRAM KT EELP41.12

Datasheet

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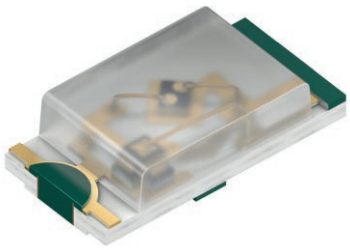
OSRAM

SMARTLED® 0603

KT EELP41.12



The SMARTLED® 0603 is the product of choice for status indication and symbol backlighting in electronics.
The small package size allows compact designs. The improved corrosion robustness and increased junction temperature range makes the devices from this series suitable for professional industrial equipment and applications.

Applications

- Appliances & Tools
- Display Backlighting
- Factory Automation
- Home & Building Automation
- Projection & Display
- Static Signaling
- Transportation

Features

- Package: SMT package 0603, colorless diffused resin
- Chip technology: Volume emitter on Sapphire (AlInGaN)
- Typ. Radiation: 130° (horizontal = 0°), 145° (vertical = 90°)
- Color: λ_{dom} = 527 nm (● true green)
- Corrosion Robustness Class: 3B
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)

Ordering Information

Type	Luminous Intensity [1] I_F = 5 mA I_v	Ordering Code
KT EELP41.12-S2U1-25-2X4Y	≥ 224 mcd	Q65113A7463

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T_{op}	min. max.	-40 °C 105 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 105 °C
Junction Temperature	T_j	max.	110 °C
Forward current T_S = 25 °C	I_F	min. max.	0.5 mA 30 mA
Forward Current pulsed D = 0.05 ; T_S = 25 °C	$I_{F\ pulse}$	max.	100 mA
Surge Current t ≤ 10 µs; D = 0.05 ; T_S = 25 °C	I_{FS}	max.	250 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V_{ESD}		8 kV
Reverse current [2)]	I_R	max.	20 mA

Characteristics

I_F = 5 mA; T_S = 25 °C

Parameter	Symbol		Values
Peak Wavelength	λ_{peak}	typ.	522 nm
Dominant Wavelength [3]	λ_{dom}	min. typ. max.	520 nm 527 nm 540 nm
Spectral Bandwidth at 50% $I_{rel,max}$	$\Delta\lambda$	typ.	26 nm
Viewing angle at 50% I_V values for 0°, 90°	2φ	typ. typ.	130 ° 145 °
Forward Voltage [4] I_F = 5 mA	V_F	min. typ. max.	2.30 V 2.50 V 3.10 V
Reverse voltage (ESD device)	$V_{R\ ESD}$	min.	7 V
Reverse voltage [2] I_R = 20 mA	V_R	max.	1.2 V
Real thermal resistance junction/solderpoint [5]	$R_{thJS\ real}$	typ. max.	440 K / W 540 K / W

Brightness Groups

Group	Luminous Intensity [1] I_F = 5 mA min. I_v	Luminous Intensity. [1] I_F = 5 mA max. I_v	Luminous Flux [6] I_F = 5 mA typ. Φ_V
S2	224 mcd	280 mcd	980 mlm
T1	280 mcd	355 mcd	1240 mlm
T2	355 mcd	450 mcd	1570 mlm
U1	450 mcd	560 mcd	1970 mlm

Forward Voltage Groups

Group	Forward Voltage [4] I_F = 5 mA min. V_F	Forward Voltage [4] I_F = 5 mA max. V_F
2X	2.30 V	2.40 V
2Y	2.40 V	2.50 V
2Z	2.50 V	2.60 V
3X	2.60 V	2.70 V
3Y	2.70 V	2.80 V
3Z	2.80 V	2.90 V
4X	2.90 V	3.00 V
4Y	3.00 V	3.10 V

Wavelength Groups

Group	Dominant Wavelength [3] min. λ_{dom}	Dominant Wavelength [3] max. λ_{dom}
2	520 nm	525 nm
3	525 nm	530 nm
4	530 nm	535 nm
5	535 nm	540 nm

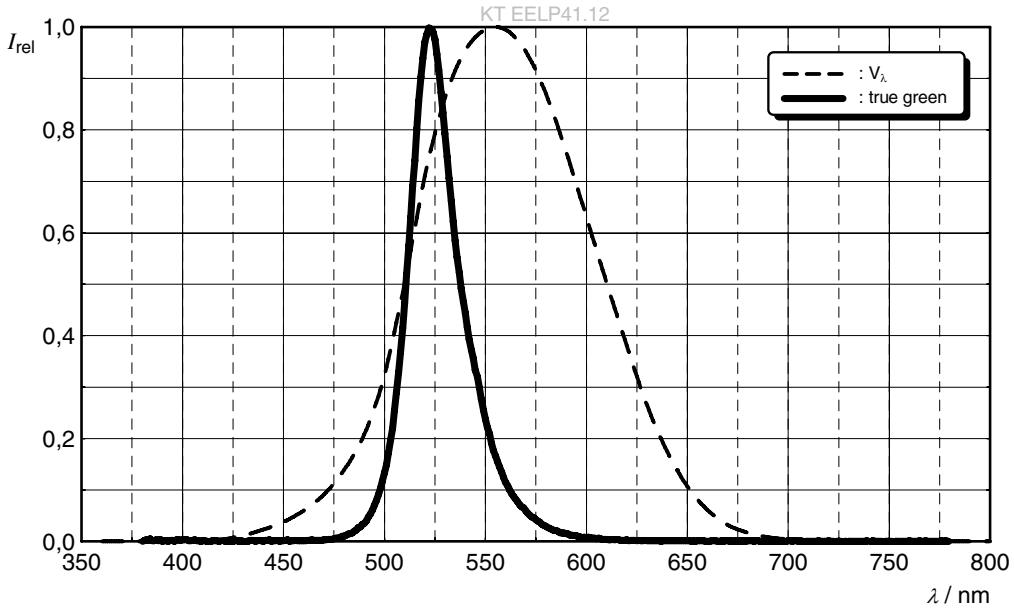
Group Name on Label

Example: S2-2-2X

Brightness	Wavelength	Forward Voltage
S2	2	2X

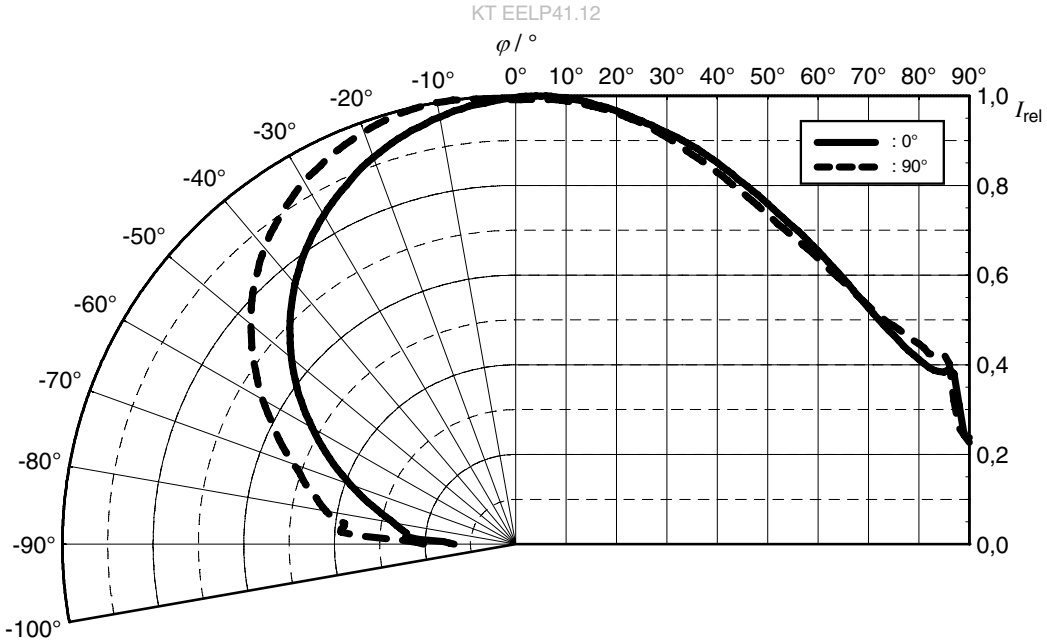
Relative Spectral Emission [6)]

$I_{rel} = f(\lambda)$; $I_F = 5$ mA; $T_S = 25$ °C



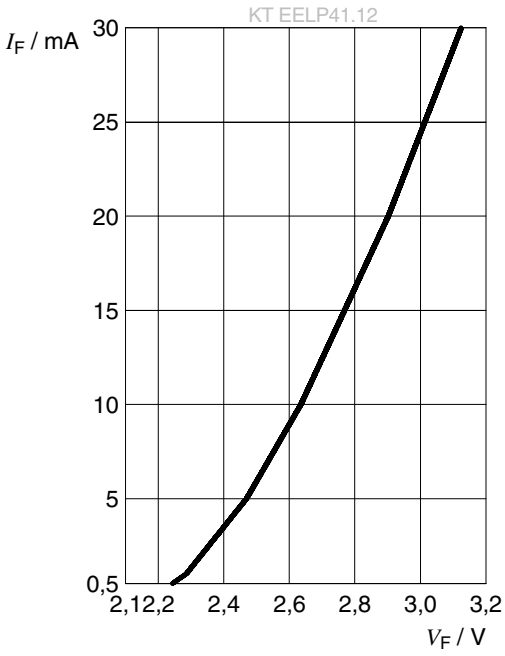
Radiation Characteristics [6)]

$I_{rel} = f(\varphi)$; $T_S = 25$ °C



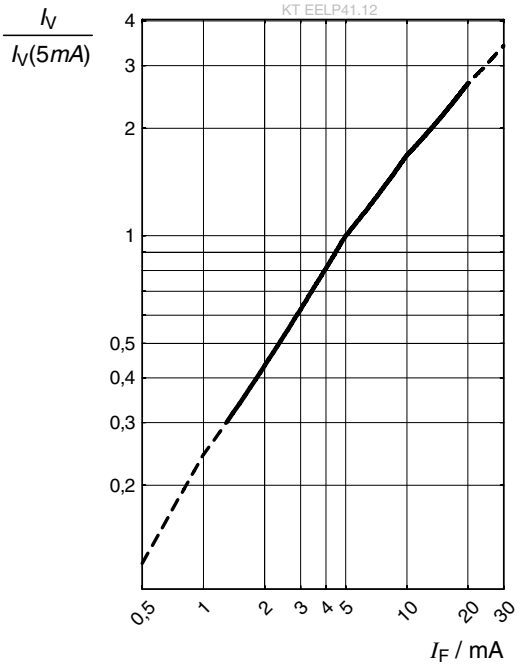
Forward current [6]

$I_F = f(V_F)$; T_S = 25 °C



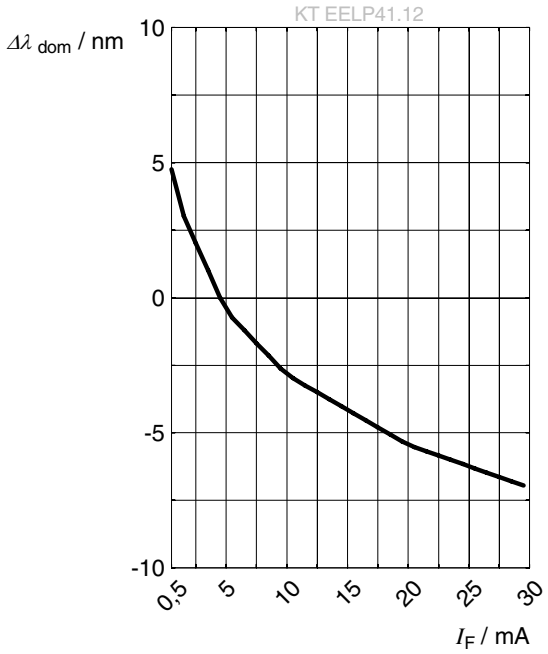
Relative Luminous Intensity [6], [7]

$I_v/I_v(5\ mA) = f(I_F)$; T_S = 25 °C



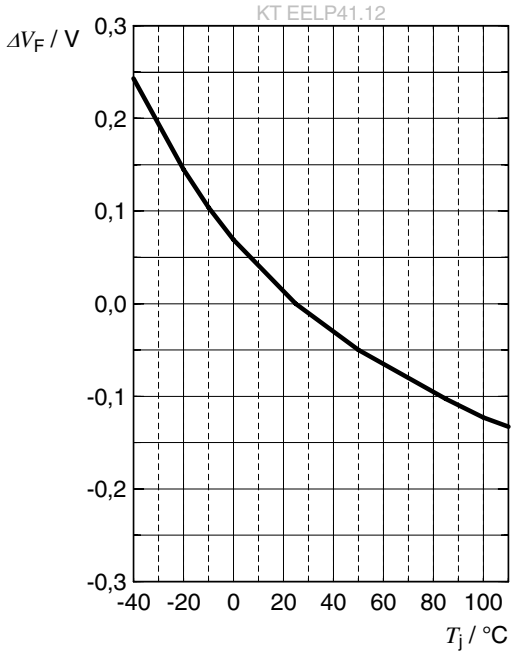
Dominant Wavelength [6]

$\Delta\lambda_{dom} = f(I_F)$; T_S = 25 °C



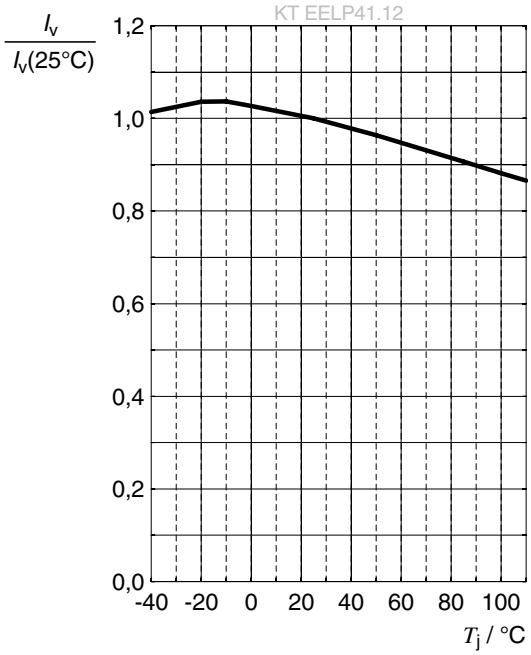
Forward Voltage [6)]

$\Delta V_F = V_F - V_F(25\ °C) = f(T_j);\ I_F = 5\ mA$



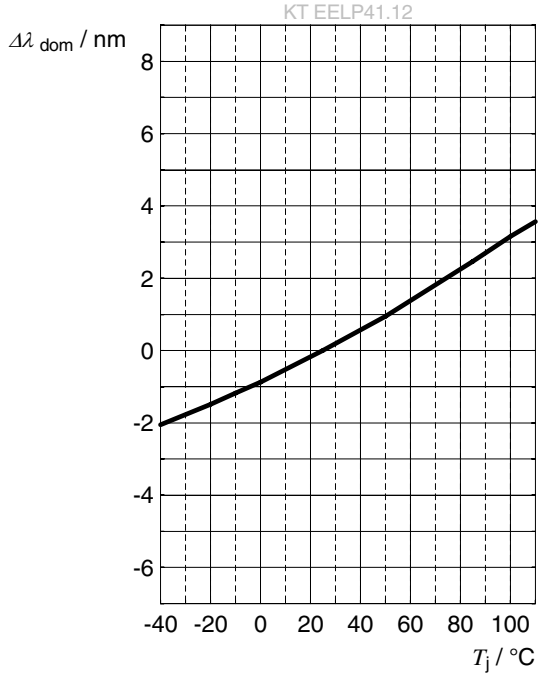
Relative Luminous Intensity [6)]

$I_v/I_v(25\ °C) = f(T_j);\ I_F = 5\ mA$



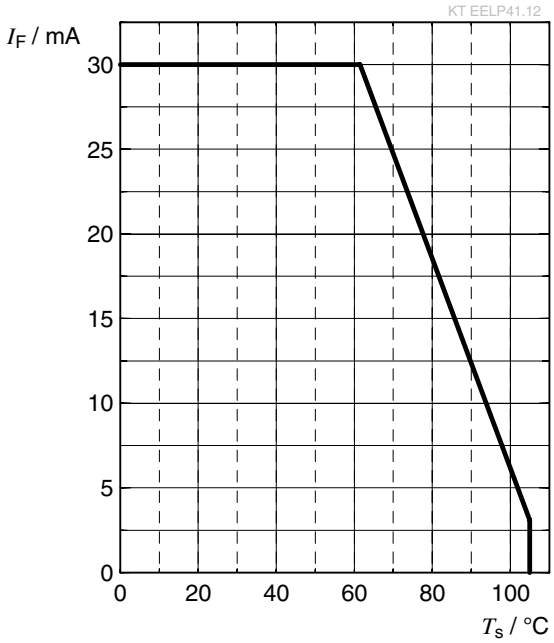
Dominant Wavelength [6)]

$\Delta\lambda_{dom} = \lambda_{dom} - \lambda_{dom}(25\ °C) = f(T_j);\ I_F = 5\ mA$



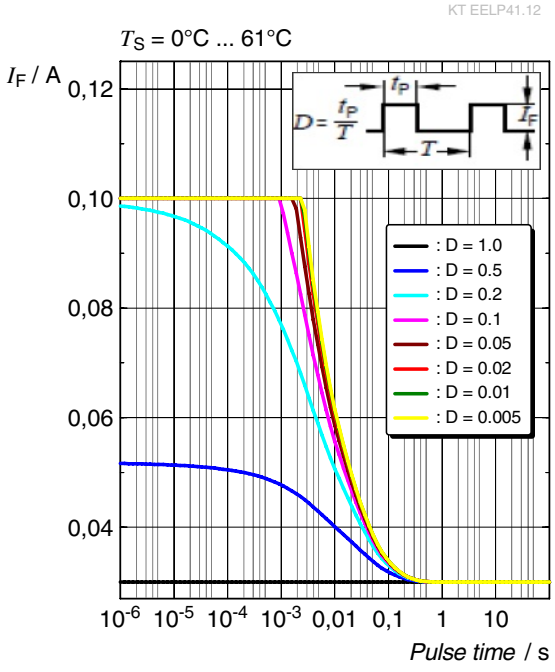
Max. Permissible Forward Current [5)]

$I_F = f(T)$



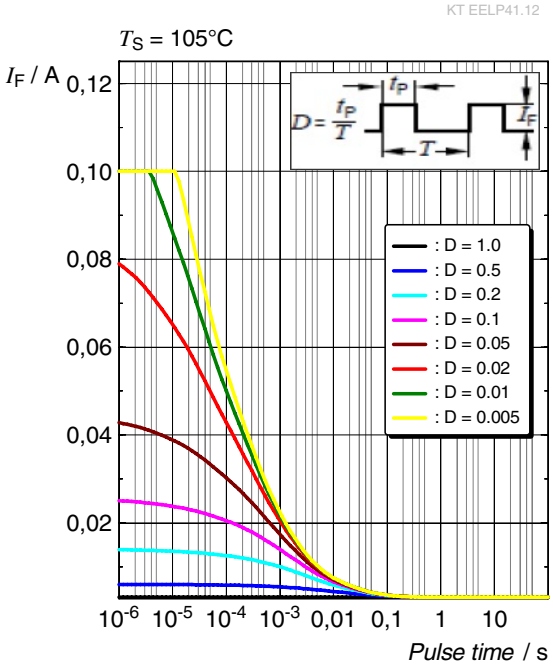
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; T_S = 25 °C

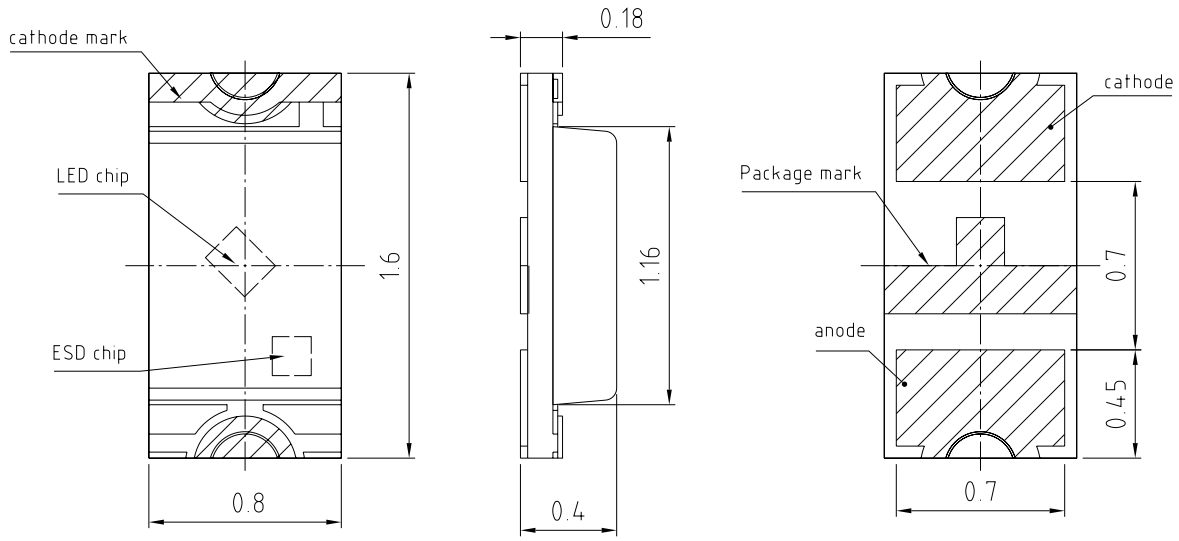


Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; T_S = 85 °C



Dimensional Drawing [8)]



general tolerance ±0.1

lead finish Au

C67062-A0484-A3-03

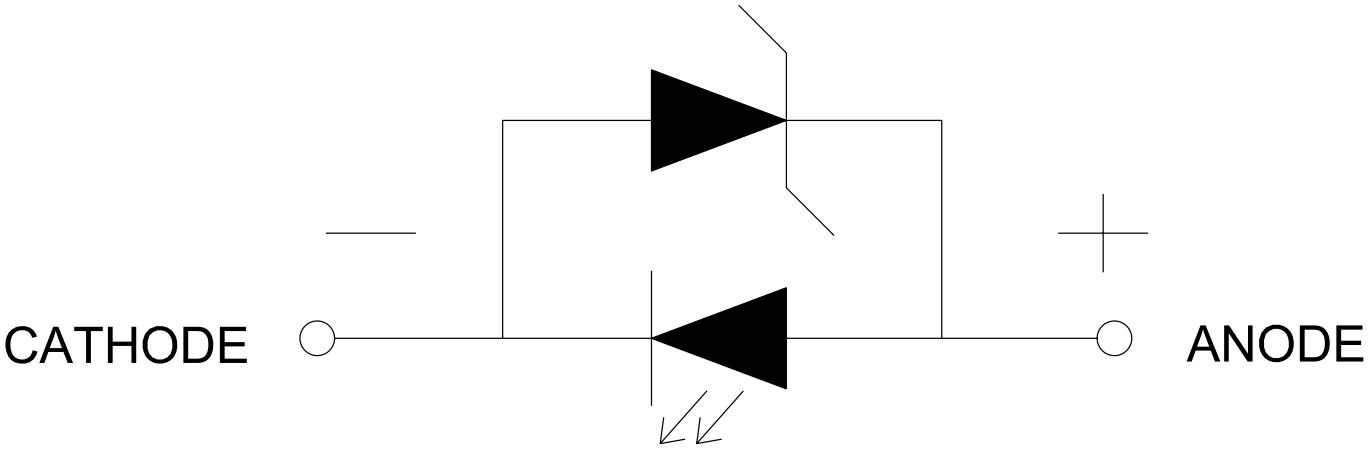
Further Information:

Approximate Weight: 1.3 mg

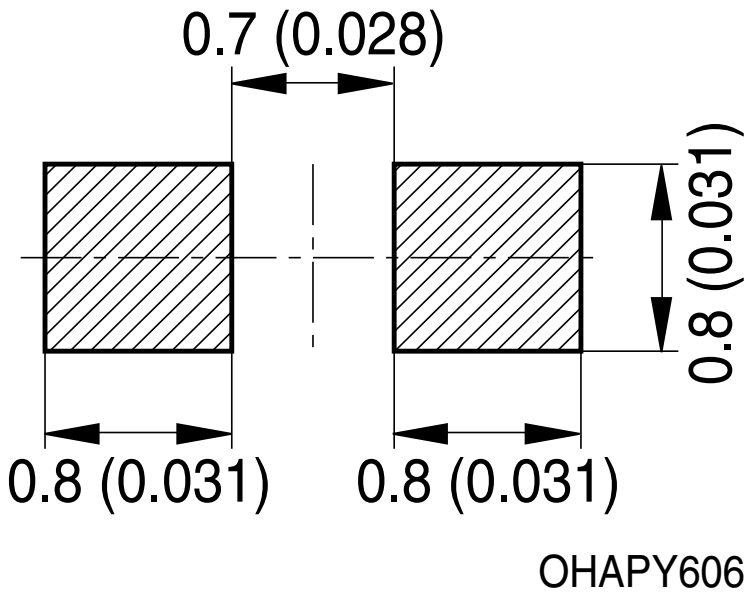
Corrosion test: Class: 3B
Test condition: 40°C / 90 % RH / 15 ppm H_2S / 14 days (stricter than IEC 60068-2-43)

ESD advice: The device is protected by ESD device which is connected in parallel to the Chip.

Electrical Internal Circuit



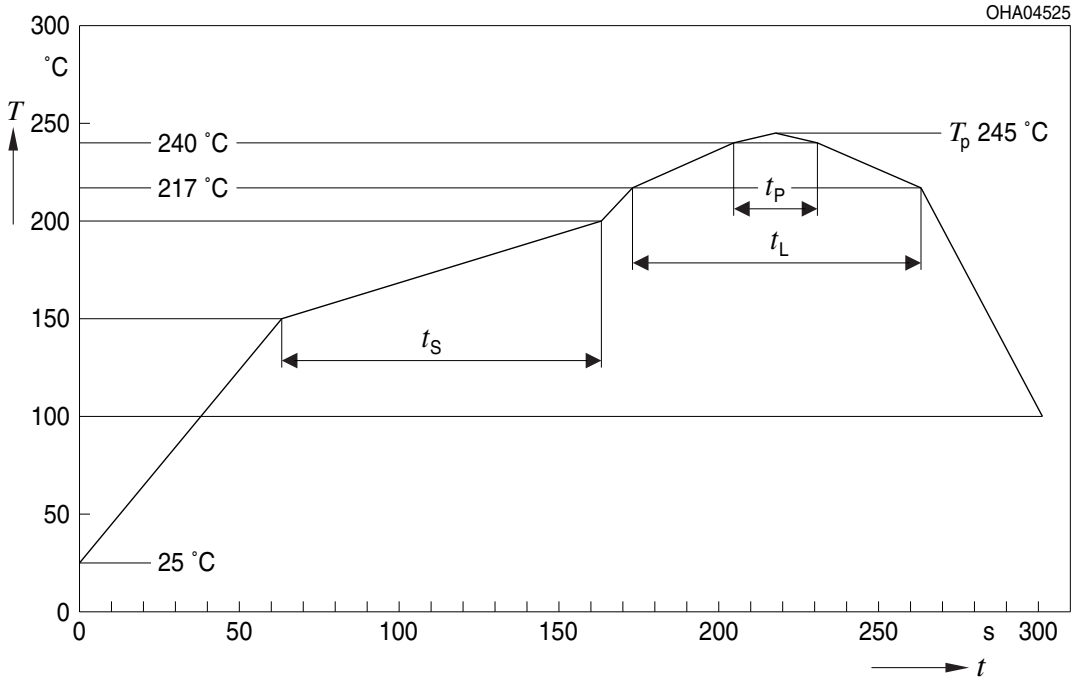
Recommended Solder Pad [8)]



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Reflow Soldering Profile

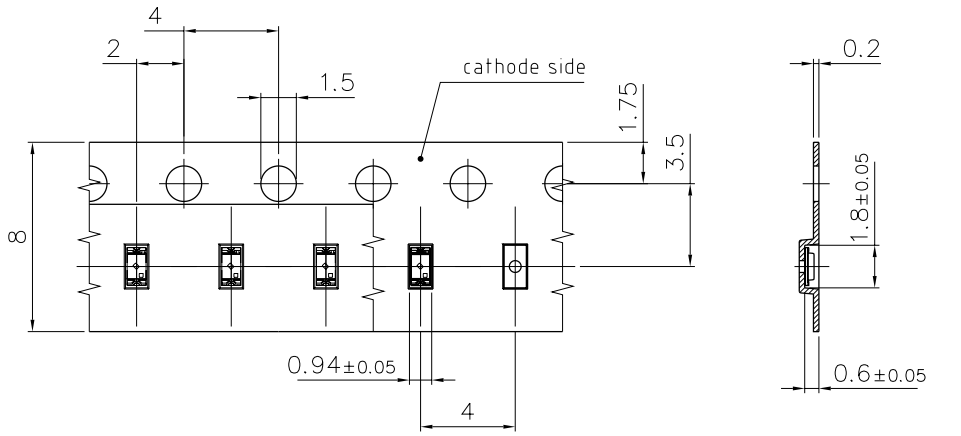
Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_S T_{Smin} to T_{Smax}	t_S	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_P			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_P		245	260	°C
Time within 5 °C of the specified peak temperature T_P - 5 K	t_P	10	20	30	s
Ramp-down rate* T_P to 100 °C			3	6	K/s
Time 25 °C to T_P				480	s

All temperatures refer to the center of the package, measured on the top of the component
* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

Taping [8)]



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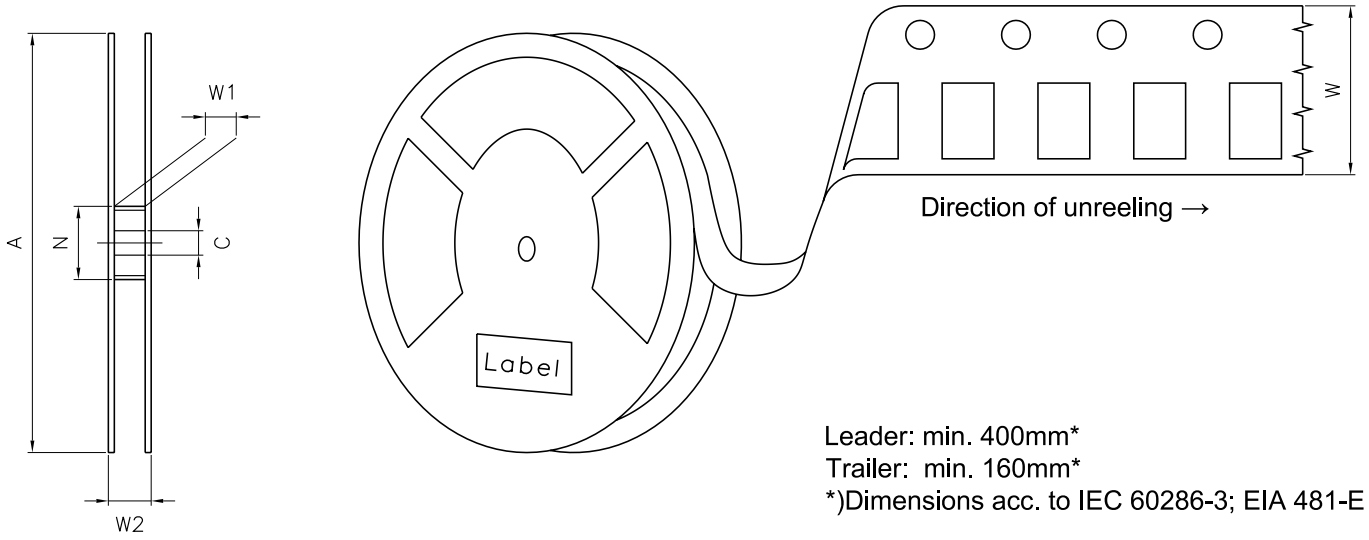
Tape and Reel [9)]

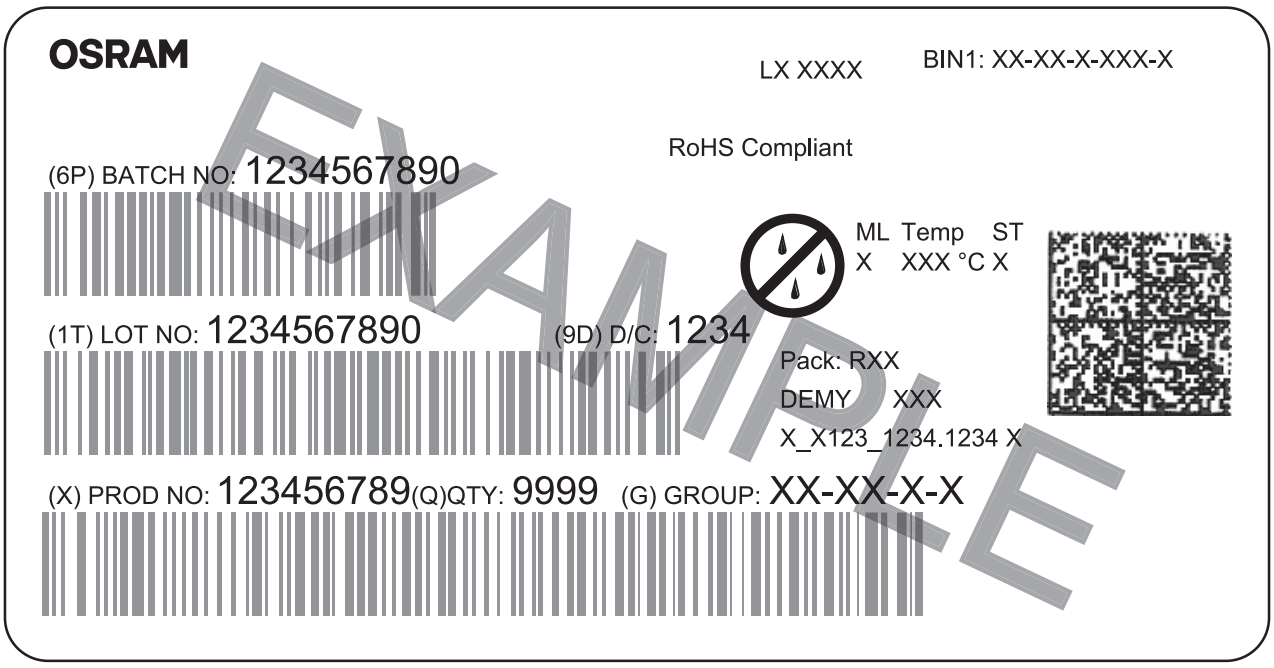


Leader: min. 400mm*
Trailer: min. 160mm*
*)Dimensions acc. to IEC 60286-3; EIA 481-E

Reel Dimensions

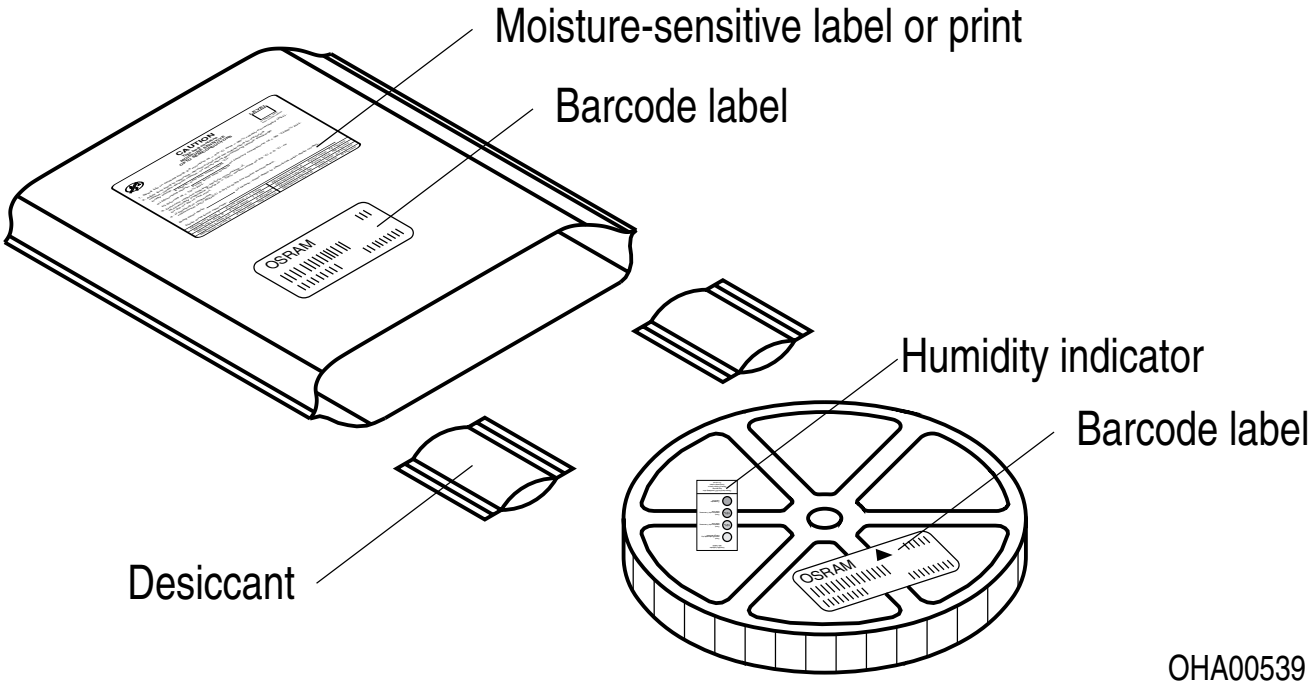
A	W	N_{min}	W_1	$W_{2\,max}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	4000

Barcode-Product-Label (BPL)



OHA04563

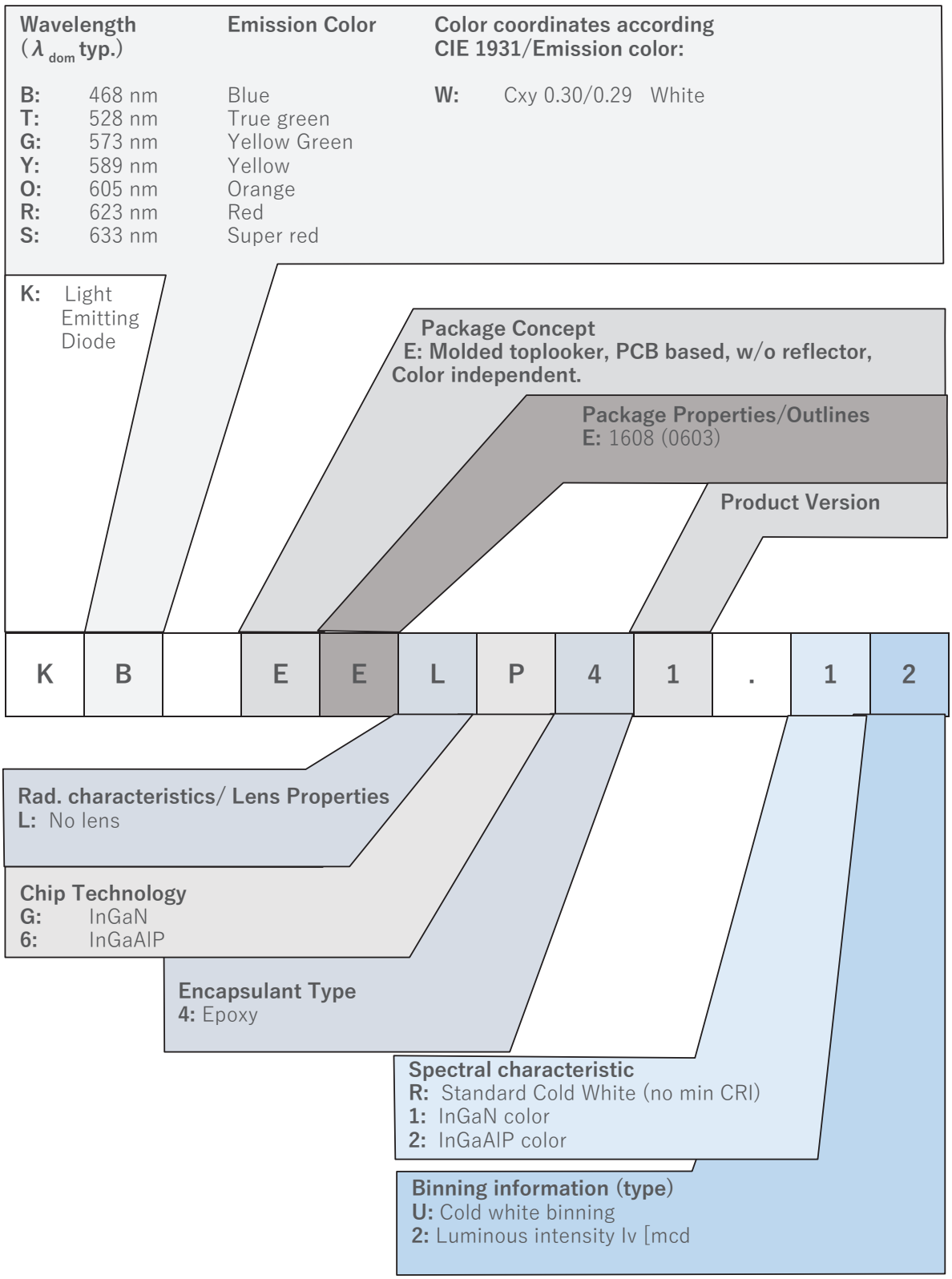
Dry Packing Process and Materials [8)]



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Type Designation System



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

Based on very short life cycle times in chip technology this component is subject to frequent adaption to the latest chip technology.

For further application related information please visit https://ams-osram.com/support/application-notes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.
For information on the types in question please contact our Sales Organization.
If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.
Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

Glossary

1) **Brightness:** Brightness groups are tested at a current pulse duration of 25 ms and a tolerance of ±11 %.

2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.

3) **Wavelength:** Wavelengths are tested at a current pulse duration of 25 ms and a tolerance of ±1 nm.

4) **Forward Voltage:** Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of ±0.1 V.

5) **Thermal Resistance:** Rth max is based on statistic values (6σ) used for Derating.

6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

7) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.

8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.

9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.0	2024-03-22	Initial Version
1.1	2024-08-30	Description

EU RoHS and China RoHS compliant product
此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，
不含有毒有害物质或元素。

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